J309, J310

Preferred Device

JFET VHF/UHF Amplifiers

N-Channel — Depletion

Features

• Pb-Free Packages are Available*

MAXIMUM RATINGS

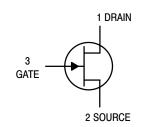
Rating	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	25	Vdc
Gate-Source Voltage	V _{GS}	25	Vdc
Forward Gate Current	I _{GF}	10	mAdc
Total Device Dissipation @ T _A = 25°C Derate above = 25°C	P _D	350 2.8	mW mW/°C
Junction Temperature Range	TJ	-65 to +125	°C
Storage Temperature Range	T _{stg}	-65 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



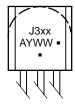
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http://onsemi.com





MARKING DIAGRAM



J3xx = Device Code

xx = 09 or 10

A = Assembly Location

Y = Year

WW = Work Week

= Pb-Free Package(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

J309, J310

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	·	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS			I.		I	
Gate – Source Breakdown Voltage ($I_G = -1.0 \mu Adc, V_{DS} = 0$)		$V_{(BR)GSS}$	-25	_	_	Vdc
Gate Reverse Current $(V_{GS} = -15 \text{ Vdc}, V_{DS} = 0, T_A = 25^{\circ}\text{C})$ $(V_{GS} = -15 \text{ Vdc}, V_{DS} = 0, T_A = +125^{\circ}\text{C})$		I _{GSS}			-1.0 -1.0	nAdc μAdc
Gate Source Cutoff Voltage (V _{DS} = 10 Vdc, I _D = 1.0 nAdc)	J309 J310	V _{GS(off)}	-1.0 -2.0	- -	-4.0 -6.5	Vdc
ON CHARACTERISTICS						
Zero-Gate-Voltage Drain Current ⁽¹⁾ (V _{DS} = 10 Vdc, V _{GS} = 0)	J309 J310	I _{DSS}	12 24	- -	30 60	mAdc
Gate-Source Forward Voltage (V _{DS} = 0, I _G = 1.0 mAdc)		$V_{GS(f)}$	-	-	1.0	Vdc
SMALL-SIGNAL CHARACTERISTICS	'		•	•	•	•
Common–Source Input Conductance (V _{DS} = 10 Vdc, I _D = 10 mAdc, f = 100 MHz)	J309 J310	Re(y _{is})	_ _	0.7 0.5	- -	mmhos
Common–Source Output Conductance (V _{DS} = 10 Vdc, I _D = 10 mAdc, f = 100 MHz)		Re(y _{os})	_	0.25	-	mmhos
Common–Gate Power Gain (V _{DS} = 10 Vdc, I _D = 10 mAdc, f = 100 MHz)		G _{pg}	-	16	-	dB
Common–Source Forward Transconductance ($V_{DS} = 10 \text{ Vdc}, I_D = 10 \text{ mAdc}, f = 100 \text{ MHz}$)		Re(y _{fs})	_	12	_	mmhos
Common–Gate Input Conductance ($V_{DS} = 10 \text{ Vdc}, I_D = 10 \text{ mAdc}, f = 100 \text{ MHz}$)		Re(y _{ig})	_	12	_	mmhos
Common–Source Forward Transconductance ($V_{DS} = 10 \text{ Vdc}$, $I_D = 10 \text{ mAdc}$, $f = 1.0 \text{ kHz}$)	J309 J310	9fs	10000 8000	- -	20000 18000	μmhos
Common–Source Output Conductance $(V_{DS} = 10 \text{ Vdc}, I_D = 10 \text{ mAdc}, f = 1.0 \text{ kHz})$		gos	_	-	250	μmhos
Common–Gate Forward Transconductance $(V_{DS} = 10 \text{ Vdc}, I_D = 10 \text{ mAdc}, f = 1.0 \text{ kHz})$	J309 J310	9 _{fg}		13000 12000		μmhos
Common–Gate Output Conductance $(V_{DS} = 10 \text{ Vdc}, I_D = 10 \text{ mAdc}, f = 1.0 \text{ kHz})$	J309 J310	9og	_ _	100 150	- -	μmhos
Gate–Drain Capacitance $(V_{DS} = 0, V_{GS} = -10 \text{ Vdc}, f = 1.0 \text{ MHz})$		C_{gd}	-	1.8	2.5	pF
Gate-Source Capacitance (V _{DS} = 0, V _{GS} = -10 Vdc, f = 1.0 MHz)		C _{gs}	_	4.3	5.0	pF
FUNCTIONAL CHARACTERISTICS						
Equivalent Short–Circuit Input Noise Voltage (V _{DS} = 10 Vdc, I _D = 10 mAdc, f = 100 Hz)		e _n	_	10	_	nV/√ Hz

^{1.} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 3.0%.

ORDERING INFORMATION

Device	Package	Shipping [†]	
J309	TO-92		
J309G	TO-92 (Pb-Free)	1000 Units / Bulk	
J310	TO-92	1000 Units / Bulk	
J310G	TO-92 (Pb-Free)		
J310RLRP	TO-92	2000 Units / Tape & Ammo Box	
J310RLRPG	TO-92 (Pb-Free)		
J310ZL1	TO-92	2000 Units / Tape & Ammo Box	
J310ZL1G	TO-92 (Pb-Free)		

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

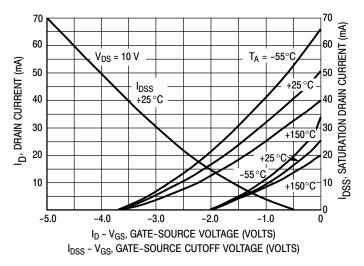


Figure 1. Drain Current and Transfer Characteristics versus Gate-Source Voltage

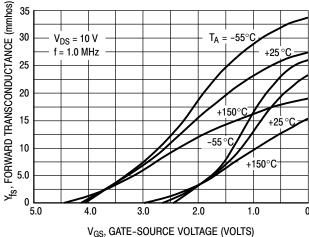


Figure 2. Forward Transconductance versus Gate-Source Voltage

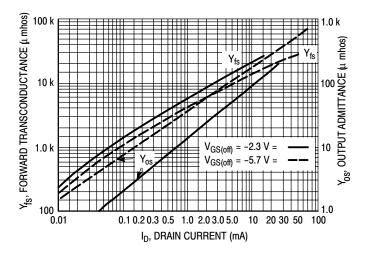


Figure 3. Common–Source Output
Admittance and Forward Transconductance
versus Drain Current

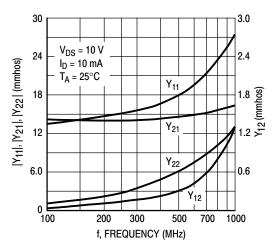


Figure 5. Common-Gate Y Parameter Magnitude versus Frequency

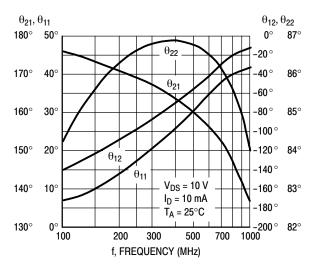


Figure 7. Common–Gate Y Parameter Phase–Angle versus Frequency

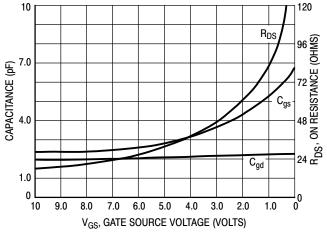


Figure 4. On Resistance and Junction Capacitance versus Gate-Source Voltage

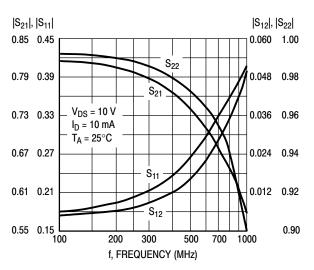


Figure 6. Common-Gate S Parameter Magnitude versus Frequency

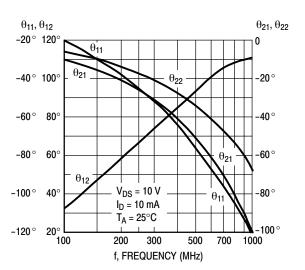
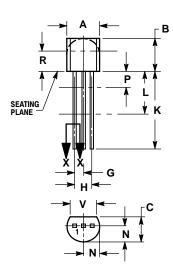
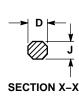


Figure 8. S Parameter Phase–Angle versus Frequency

PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 ISSUE AL





NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
 V14 5M 1982
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.
- 3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
- LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INC	NCHES MILLIM		ETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.175	0.205	4.45	5.20	
В	0.170	0.210	4.32	5.33	
c	0.125	0.165	3.18	4.19	
D	0.016	0.021	0.407	0.533	
G	0.045	0.055	1.15	1.39	
Н	0.095	0.105	2.42	2.66	
J	0.015	0.020	0.39	0.50	
K	0.500		12.70		
L	0.250		6.35		
N	0.080	0.105	2.04	2.66	
P		0.100		2.54	
R	0.115		2.93		
٧	0.135		3.43		

STYLE 5: PIN 1.

PIN 1. DRAIN

2. SOURCE

3. GATE

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